74HC4094; 74HCT4094 8-stage shift-and-store bus register Rev. 7 – 10 February 2016

General description 1.

The 74HC4094; 74HCT4094 is an 8-bit serial-in/serial or parallel-out shift register with a storage register and 3-state outputs. Both the shift and storage register have separate clocks. The device features a serial input (D) and two serial outputs (QS1 and QS2) to enable cascading. Data is shifted on the LOW-to-HIGH transitions of the CP input. Data is available at QS1 on the LOW-to-HIGH transitions of the CP input to allow cascading when clock edges are fast. The same data is available at QS2 on the next HIGH-to-LOW transition of the CP input to allow cascading when clock edges are slow. The data in the shift register is transferred to the storage register when the STR input is HIGH. Data in the storage register appears at the outputs whenever the output enable input (OE) is HIGH. A LOW on OE causes the outputs to assume a high-impedance OFF-state. Operation of the OE input does not affect the state of the registers. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. Features and benefits

- Complies with JEDEC standard JESD7A
- Input levels:
 - For 74HC4094: CMOS level
 - For 74HCT4094: TTL level
- Low-power dissipation
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C

Applications 3.

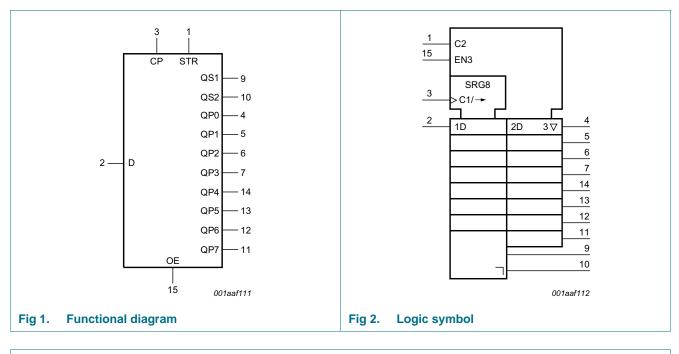
- Serial-to-parallel data conversion
- Remote control holding register

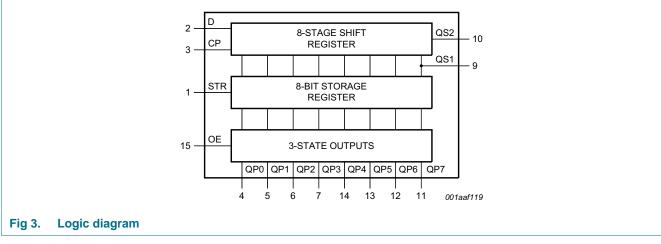


4. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC4094D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width	SOT109-1
74HCT4094D			3.9 mm	
74HC4094DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads;	SOT338-1
74HCT4094DB			body width 5.3 mm	
74HC4094PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

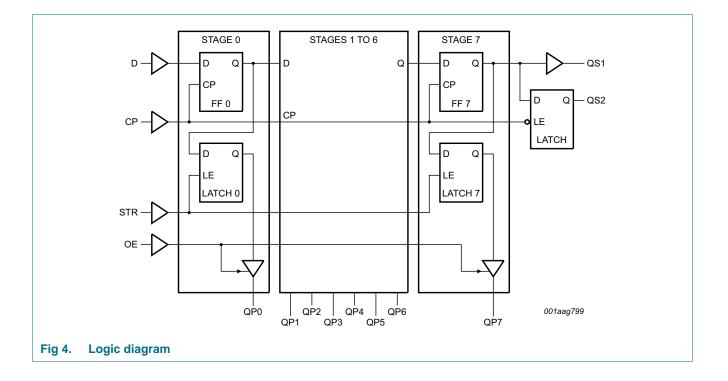
5. Functional diagram





Product data sheet

8-stage shift-and-store bus register

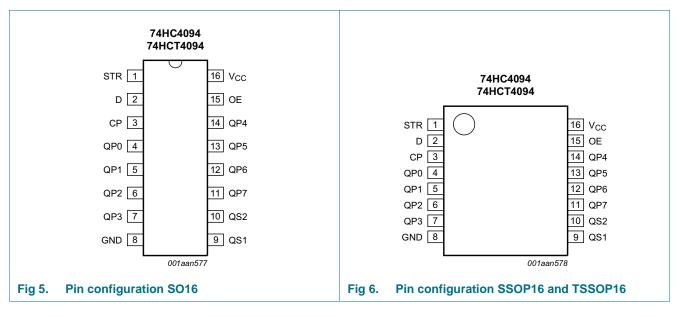


74HC_HCT4094

8-stage shift-and-store bus register

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2.Pin description

Symbol	Pin	Description
STR	1	strobe input
D	2	data input
СР	3	clock input
QP0 to QP7	4, 5, 6, 7, 14, 13, 12, 11	parallel output
V _{SS}	8	ground supply voltage
QS1, QS2	9, 10	serial output
OE	15	output enable input
V _{DD}	16	supply voltage

Functional description 7.

Table 3.	Function tab	le <u>^[1]</u>					
Inputs					outputs	Serial out	puts
СР	OE	STR	D	QP0	QPn	QS1	QS2
\uparrow	L	Х	Х	Z	Z	Q6S	NC
\downarrow	L	Х	Х	Z	Z	NC	Q7S
↑	Н	L	Х	NC	NC	Q6S	NC
↑	Н	Н	L	L	QPn –1	Q6S	NC
↑	Н	Н	Н	Н	QPn –1	Q6S	NC
\downarrow	Н	Н	Н	NC	NC	NC	Q7S

[1] At the positive clock edge, the information in the 7th register stage is transferred to the 8th register stage and the QSn outputs.

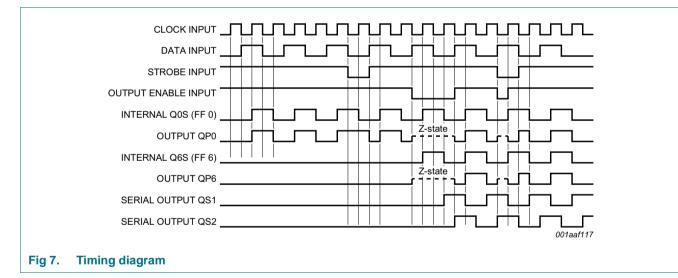
H = HIGH voltage level; L = LOW voltage level; X = don't care;

 \uparrow = positive-going transition; \downarrow = negative-going transition;

Z = HIGH-impedance OFF-state; NC = no change;

Q6S = the data in register stage 6 before the LOW to HIGH clock transition;

Q7S = the data in register stage 7 before the HIGH to LOW clock transition.



8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _{ОК}	output clamping current	V_{O} < -0.5 V or V_{O} > V_{CC} + 0.5 V		-	±20	mA
lo	output current	$V_{O} = -0.5 \text{ V to} (V_{CC} + 0.5 \text{ V})$		-	±25	mA
I _{CC}	supply current			-	+50	mA
I _{GND}	ground current			-	-50	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO16, SSOP16 and TSSOP16 packages	<u>[1]</u>	-	500	mW

For SO16: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For SSOP16 and TSSOP16 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	7	74HC4094			74HCT4094		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC40	94									
VIH	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
VIL	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = -20 \ \mu A; V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
l _{oz}	OFF-state output current		-	-	±0.5	-	±5.0	-	±10.0	μA
l _{cc}	supply current		-	-	8.0	-	80	-	160	μA
CI	input capacitance		-	3.5	-					pF
74HCT4	094									
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{он}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V

Product data sheet

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8-stage shift-and-store bus register

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current		-	-	±0.5	-	±5.0	-	±10	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	-	80	-	160	μA
ΔI _{CC}	additional supply current	$\label{eq:VI} \begin{array}{l} V_I = V_{CC} - 2.1 \ V; \\ \text{other inputs at } V_{CC} \ \text{or GND}; \\ V_{CC} = 4.5 \ V \ \text{to } 5.5 \ V; \\ I_O = 0 \ \text{A} \end{array}$								
		per input pin; STR input	-	100	360	-	450	-	490	μA
		per input pin; OE input	-	150	540	-	675	-	735	μA
		per input pin; CP input	-	150	540	-	675	-	735	μA
		per input pin; D input	-	40	144	-	180	-	196	μA
CI	input capacitance		-	3.5	-					pF

8-stage shift-and-store bus register

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions		25 °C		–40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Мах	Min	Max	Min	Max	
74HC40	94			-1	-	1			1	-
t _{pd}	propagation	CP to QS1; see Figure 8	1]							
	delay	V _{CC} = 2.0 V	-	50	150	-	190	-	225	ns
		V _{CC} = 4.5 V	-	18	30	-	38	-	45	ns
		V _{CC} = 5 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	26	-	33	-	38	ns
		CP to QS2; see Figure 8	1]							
		V _{CC} = 2.0 V	-	44	135	-	170	-	205	ns
		V _{CC} = 4.5 V	-	16	27	-	34	-	41	ns
		V _{CC} = 5 V; C _L = 15 pF	-	13	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	13	23	-	29	-	35	ns
		CP to QPn; see Figure 8	1]							
		V _{CC} = 2.0 V	-	63	195	-	245	-	295	ns
		V _{CC} = 4.5 V	-	23	39	-	49	-	59	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	33	-	42	-	50	ns
		STR to QPn; see Figure 9	1]							
		V _{CC} = 2.0 V	-	58	180	-	225	-	270	ns
		V _{CC} = 4.5 V	-	21	36	-	45	-	54	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	18	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	17	31	-	38	-	46	ns
t _{en}	enable time	OE to QPn; see Figure 11	2]							
		V _{CC} = 2.0 V	-	55	175	-	220	-	265	ns
		V _{CC} = 4.5 V	-	20	35	-	44	-	53	ns
		V _{CC} = 6.0 V	-	16	30	-	37	-	45	ns
t _{dis}	disable time	OE to QPn; see Figure 11	3]							
		V _{CC} = 2.0 V	-	41	125	-	155	-	190	ns
		V _{CC} = 4.5 V	-	15	25	-	31	-	38	ns
		V _{CC} = 6.0 V	-	12	21	-	26	-	32	ns
t _t	transition time	QPn and QSn; see	<u>4]</u>							
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns

Symbol	Parameter	Conditions		25 °C		–40 °C 1	to +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _W	pulse width	CP HIGH or LOW; see Figure 8								
		V _{CC} = 2.0 V	80	14	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	5	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	4	-	17	-	20	-	ns
		STR HIGH; see Figure 9								
		V _{CC} = 2.0 V	80	14	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	5	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	4	-	17	-	20	-	ns
t _{su}	set-up time	D to CP; see Figure 10								
		V _{CC} = 2.0 V	50	14	-	65	-	75	-	ns
		$V_{CC} = 4.5 V$	10	5	-	13	-	15	-	ns
		V _{CC} = 6.0 V	9	4	-	11	-	13	-	ns
		CP to STR; see Figure 9								
		V _{CC} = 2.0 V	100	28	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	10	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	8	-	21	-	26	-	ns
t _h	hold time	D to CP; see Figure 10								
		V _{CC} = 2.0 V	3	-6	-	3	-	3	-	ns
		V _{CC} = 4.5 V	3	-2	-	3	-	3	-	ns
		V _{CC} = 6.0 V	3	-2	-	3	-	3	-	ns
		CP to STR; see Figure 9								
		V _{CC} = 2.0 V	0	-14	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-5	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-4	-	0	-	0	-	ns
f _{max}	maximum	CP; see Figure 8								
	frequency	V _{CC} = 2.0 V	6.0	28	-	4.8	-	4.0	-	MHz
		V _{CC} = 4.5 V	30	87	-	24	-	20	-	MHz
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	95	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	35	103	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	$\begin{array}{ll} C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz}; & [5] \\ V_I = GND \text{ to } V_{CC} \end{array}$	-	83	-	-	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions			25 °C		-40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	-
74HCT4	094	1									
t _{pd}	propagation	CP to QS1; see Figure 8	<u>[1]</u>								
	delay	V _{CC} = 4.5 V		-	23	39	-	49	-	59	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	19	-	-	-	-	-	ns
		CP to QS2; see Figure 8	[1]								
		V _{CC} = 4.5 V		-	21	36	-	45	-	54	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	18	-	-	-	-	-	ns
		CP to QPn; see Figure 8	[1]								
		V _{CC} = 4.5 V		-	25	43	-	54	-	65	ns
		V _{CC} = 5 V; C _L = 15 pF		-	21	-	-	-	-	-	ns
		STR to QPn; see Figure 9	[1]								
		V _{CC} = 4.5 V		-	22	39	-	49	-	59	ns
		V _{CC} = 5 V; C _L = 15 pF		-	19	-	-	-	-	-	ns
t _{en}	enable time	OE to QPn; see Figure 11	[2]								
		V _{CC} = 4.5 V		-	20	35	-	44	-	53	ns
t _{dis}	t _{dis} disable time	OE to QPn; see Figure 11	[3]								
		V _{CC} = 4.5 V		-	21	35	-	44	-	53	ns
t _t	transition time	QPn and QSn; see Figure 8	<u>[4]</u>								
		V _{CC} = 4.5 V		-	7	15	-	19	-	22	ns
t _W	pulse width	CP HIGH or LOW; see Figure 8									
		V _{CC} = 4.5 V		16	7	-	20	-	24	-	ns
		STR HIGH; see Figure 9									
		V _{CC} = 4.5 V		16	5	-	20	-	24	-	ns
t _{su}	set-up time	Dn to CP; see Figure 10									
		V _{CC} = 4.5 V		10	4	-	13	-	15	-	ns
		CP to STR; see Figure 9									
		V _{CC} = 4.5 V		20	9	-	25	-	30	-	ns
t _h	hold time	Dn to CP; see Figure 10									
		V _{CC} = 4.5 V		4	0	-	4	-	4	-	ns
		CP to STR; see Figure 9									
		V _{CC} = 4.5 V		0	-4	-	0	-	0	-	ns
f _{max}	maximum	CP; see Figure 8									
	frequency	V _{CC} = 4.5 V		30	80	-	24	-	20	-	MHz
		V _{CC} = 5 V; C _L = 15 pF		-	86	-	-	-	-	-	MHz

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

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Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
C _{PD}	power dissipation capacitance	$C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC} - 1.5 \text{ V}$	-	92	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

[2] t_{en} is the same as t_{PZH} and t_{PZL} .

[3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[4] t_t is the same as t_{THL} and t_{TLH} .

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

fo = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

12. Waveforms

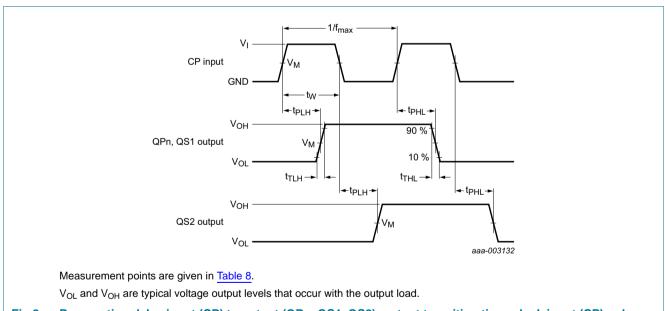
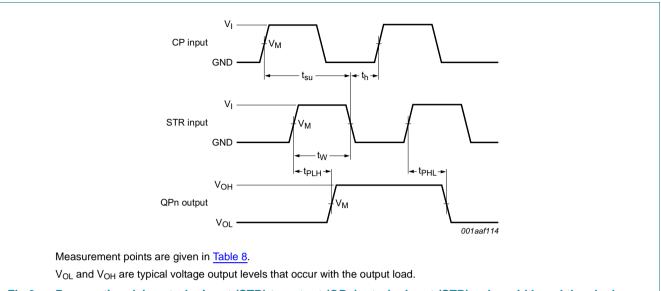
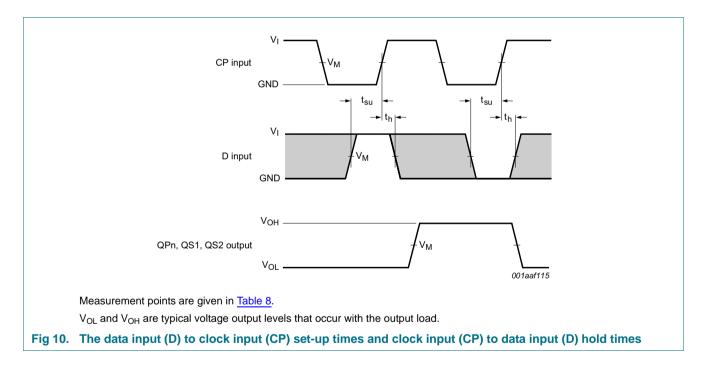


Fig 8. Propagation delay input (CP) to output (QPn, QS1, QS2), output transition time, clock input (CP) pulse width and the maximum frequency (CP)

8-stage shift-and-store bus register







8-stage shift-and-store bus register

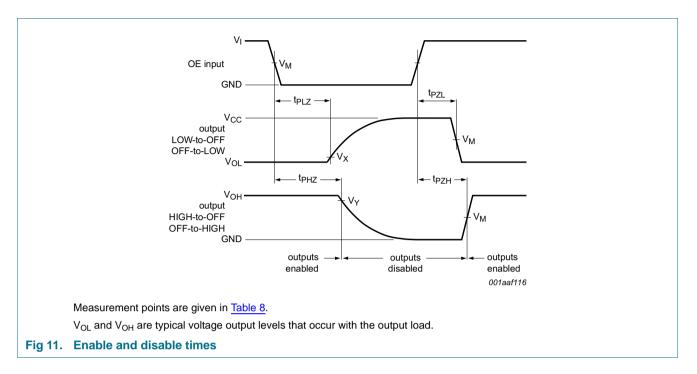


Table 8.Measurement points

Туре	Input	Output		
	V _M	V _M	V _X	V _Y
74HC4094	0.5V _{CC}	0.5V _{CC}	0.1V _{OH}	0.9V _{OH}
74HCT4094	1.3 V	1.3 V	0.1V _{OH}	0.9V _{OH}

8-stage shift-and-store bus register

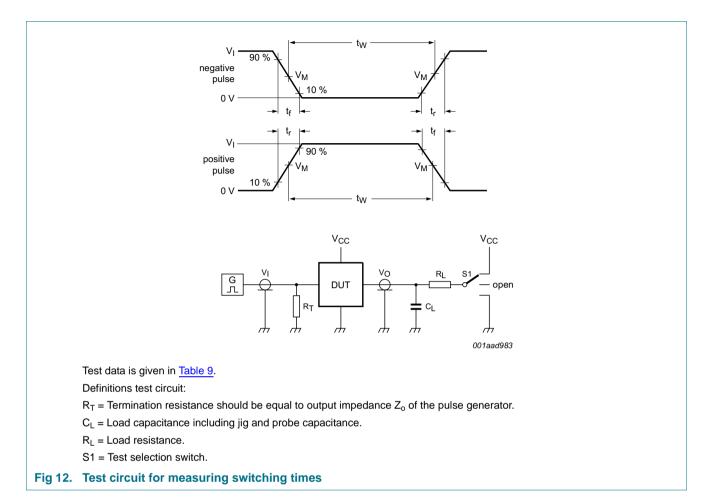


Table 9. Test data

Туре	Input		Load		S1 position		
	Vi	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74HC4094	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74HCT4094	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

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13. Package outline

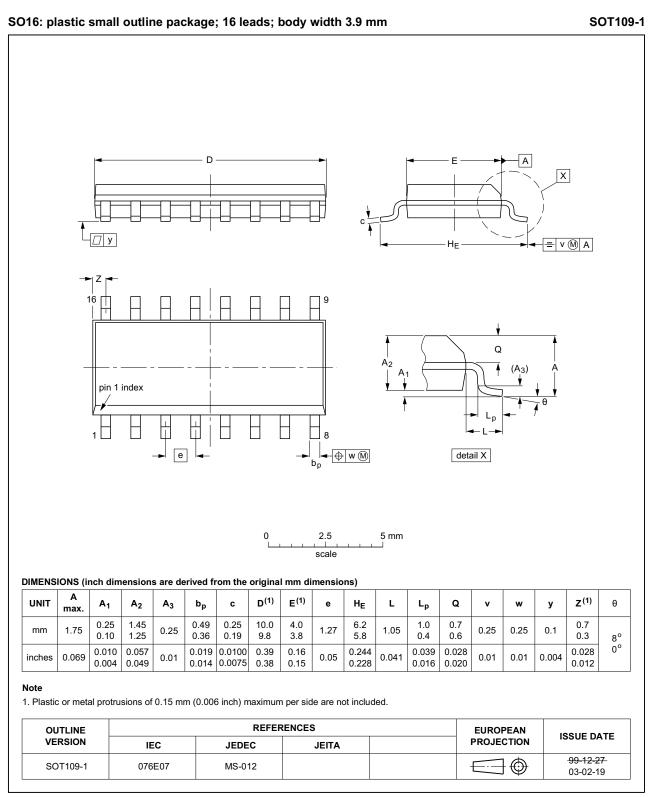


Fig 13. Package outline SOT109-1 (SO16)

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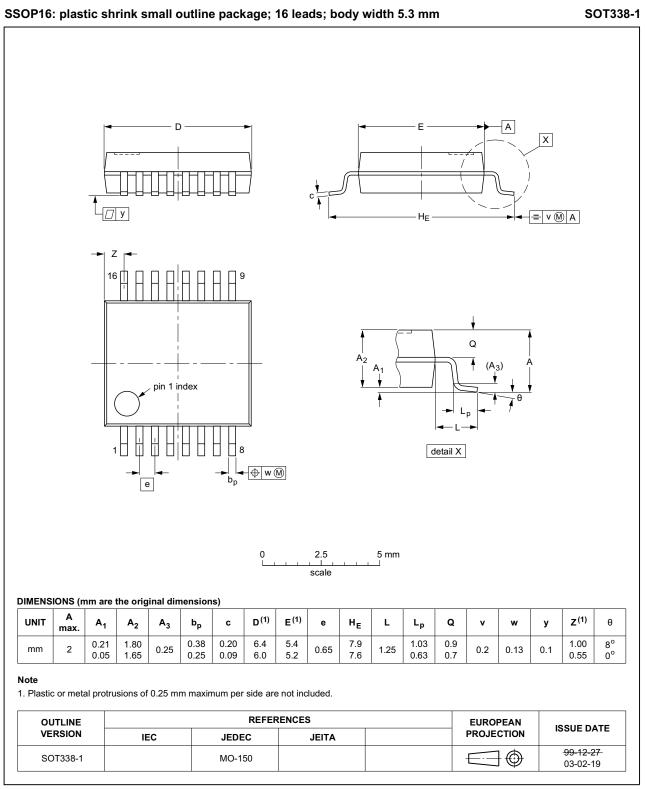


Fig 14. Package outline SOT338-1 (SSOP16)

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Product data sheet

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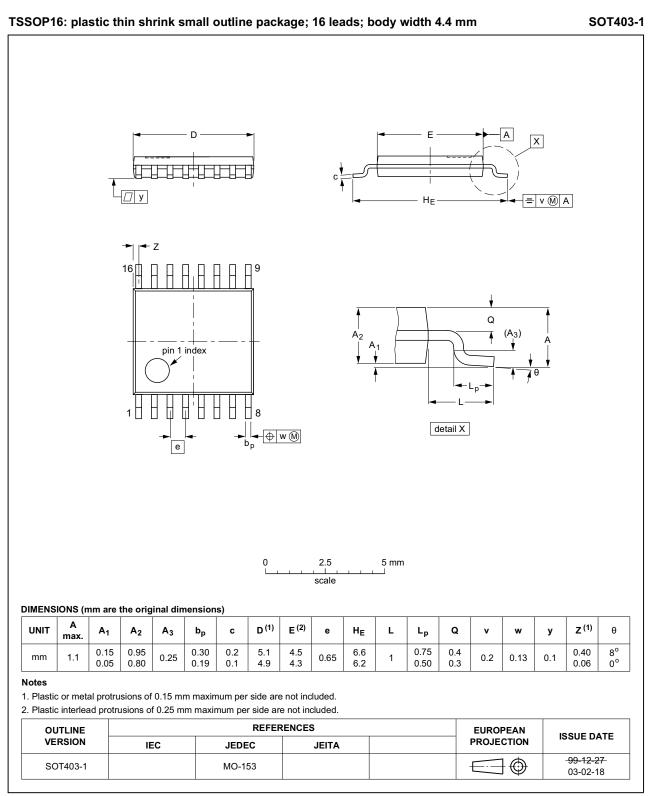


Fig 15. Package outline SOT403-1 (TSSOP16)

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Product data sheet

14. Abbreviations

Table 10. Abbreviations			
Acronym	Description		
CMOS	Complementary Metal Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

15. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT4094 v.7	20160210	Product data sheet	-	74HC_HCT4094 v.6	
Modifications:	Type numbers 74HC4094N and 74HCT4094N (SOT38-4) removed.				
74HC_HCT4094 v.6	20121231	Product data sheet	-	74HC_HCT4094 v.5	
Modifications:	General description updated.				
74HC_HCT4094 v.5	20120628	Product data sheet	-	74HC_HCT4094 v.4	
Modifications:	 V_X and V_Y measurement points added to Table 8. 				
74HC_HCT4094 v.4	20111219	Product data sheet	-	74HC_HCT4094 v.3	
Modifications:	Legal pages updated.				
74HC_HCT4094 v.3	20110214	Product data sheet	-	74HC_HCT4094_CNV v.2	
74HC_HCT4094_CNV v.2	19970901	Product specification	-	-	

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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